## NLX1G11

## 3-Input AND Gate

The NLX1G11 is an advanced high-speed 3-input CMOS AND gate in ultra-small footprint.

The NLX1G11 input structures provide protection when voltages up to 7.0 V are applied, regardless of the supply voltage.

## Features

- High Speed: $\mathrm{t}_{\mathrm{PD}}=2.4 \mathrm{~ns}$ (Typ) @ $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$
- Designed for 1.65 V to 5.5 V VCC Operation
- Low Power Dissipation: $\mathrm{I}_{\mathrm{CC}}=1 \mu \mathrm{~A}$ (Max) at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
- 24 mA Balanced Output Source and Sink Capability
- Balanced Propagation Delays
- Overvoltage Tolerant (OVT) Input Pins
- Ultra-Small Packages
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are $\mathrm{Pb}-$ Free Devices


Figure 1. Pinout (Top View)
PIN ASSIGNMENT

| Pin | Function |
| :---: | :---: |
| 1 | A |
| 2 | GND |
| 3 | B |
| 4 | Y |
| 5 | $\mathrm{~V}_{\mathrm{CC}}$ |
| 6 | C |

FUNCTION TABLE

| Input |  |  | Output |
| :---: | :---: | :---: | :---: |
| A | B | C | Y |
| L | X | X | L |
| X | L | X | L |
| X | X | L | L |
| H | H | H | H |

[^0]

Figure 2. Logic Symbol

MARKING DIAGRAMS


1


X = Device Marking
M = Date Code

- = Pb-Free Package

ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

## NLX1G11

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage | -0.5 to +7.0 | V |
| $\mathrm{V}_{\text {IN }}$ | DC Input Voltage | -0.5 to +7.0 | V |
| $\mathrm{V}_{\text {OUT }}$ | DC Output Voltage | -0.5 to +7.0 | V |
| $\mathrm{I}_{\text {K }}$ | DC Input Diode Current $\quad \mathrm{V}_{\text {IN }}<$ GND | -50 | mA |
| IOK | DC Output Diode Current $\quad V_{\text {OUT }}<$ GND | -50 | mA |
| Io | DC Output Source/Sink Current | $\pm 50$ | mA |
| $I_{\text {cc }}$ | DC Supply Current per Supply Pin | $\pm 100$ | mA |
| $\mathrm{I}_{\text {GND }}$ | DC Ground Current per Ground Pin | $\pm 100$ | mA |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead Temperature, 1 mm from Case for 10 Seconds | 260 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{J}$ | Junction Temperature Under Bias | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\text {JA }}$ | Thermal Resistance (Note 1) | 496 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation in Still Air @ 85 ${ }^{\circ} \mathrm{C}$ | 252 | mW |
| MSL | Moisture Sensitivity | Level 1 |  |
| $\mathrm{F}_{\mathrm{R}}$ | Flammability Rating Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in |  |
| $\mathrm{V}_{\text {ESD }}$ | ESD Withstand VoltageHuman Body Model (Note 2) <br> Machine Model (Note 3) <br> Charged Device Model (Note 4) | $\begin{gathered} \hline>2000 \\ >200 \\ \mathrm{~N} / \mathrm{A} \end{gathered}$ | V |
| I LATCHUP | Latchup Performance Above $\mathrm{V}_{\text {CC }}$ and Below GND at $125^{\circ} \mathrm{C}$ (Note 5) | $\pm 500$ | mA |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm -by-1 inch, 2 ounce copper trace no air flow.
2. Tested to EIA/JESD22-A114-A.
3. Tested to EIA/JESD22-A115-A.
4. Tested to JESD22-C101-A.
5. Tested to EIA / JESD78.

## RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Positive DC Supply Voltage | Operating Data Retention Only | $\begin{aligned} & 1.65 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 5.5 \end{aligned}$ | V |
| $\mathrm{V}_{\text {IN }}$ | Digital Input Voltage (Note 6) |  | 0 | 5.5 | V |
| $\mathrm{V}_{\text {OUT }}$ | Output Voltage |  | 0 | 5.5 | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Free-Air Temperature |  | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta t / \Delta \mathrm{V}$ | Input Transition Rise or Fall Rate | $\begin{gathered} \hline \mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V} \pm 0.15 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CC}}=2.5 \mathrm{~V} \pm 0.2 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V} \end{gathered}$ | $\begin{aligned} & \hline 0 \\ & 0 \\ & 0 \\ & 0 \end{aligned}$ | $\begin{gathered} 20 \\ 20 \\ 10 \\ 5 \end{gathered}$ | $\mathrm{ns} / \mathrm{V}$ |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
6. Unused inputs may not be left open. All inputs must be tied to a high or low-logic input voltage level.

## NLX1G11

DC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{cc}}$ <br> (V) | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Low-Level Input Voltage |  | 1.65 | $0.75 \times \mathrm{V}_{\text {CC }}$ |  |  | $0.75 \times \mathrm{V}_{\text {cC }}$ |  | V |
|  |  |  | 2.3 to 5.5 | $0.70 \times \mathrm{V}_{\text {cc }}$ |  |  | $0.70 \times \mathrm{V}_{\text {cC }}$ |  |  |
| $\mathrm{V}_{\text {IL }}$ | Low-Level Input Voltage |  | 1.65 |  |  | $0.25 \times \mathrm{V}_{\mathrm{CC}}$ |  | $0.25 \times \mathrm{V}_{\mathrm{CC}}$ | V |
|  |  |  | 2.3-5.5 |  |  | $0.30 \times V_{\text {CC }}$ |  | $0.30 \times \mathrm{V}_{\mathrm{CC}}$ |  |
| $\mathrm{V}_{\mathrm{OH}}$ | HighLevel Output Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A} \end{aligned}$ | 1.65-5.5 | $\mathrm{V}_{\mathrm{CC}}-0.1$ | $\mathrm{V}_{\mathrm{CC}}$ |  | $\mathrm{V}_{\mathrm{CC}}-0.1$ |  | V |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-12 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-16 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-24 \mathrm{~mA} \\ & \text { and } \end{aligned}$ | $\begin{gathered} 1.65 \\ 2.3 \\ 2.7 \\ 3.0 \\ 3.0 \\ 4.5 \end{gathered}$ | $\begin{aligned} & 1.29 \\ & 1.9 \\ & 2.2 \\ & 2.4 \\ & 2.3 \\ & 3.8 \end{aligned}$ | $\begin{gathered} 1.52 \\ 2.15 \\ 2.4 \\ 2.8 \\ 2.68 \\ 4.2 \end{gathered}$ |  | $\begin{gathered} 1.29 \\ 1.9 \\ 2.2 \\ 2.4 \\ 2.3 \\ 3.8 \end{gathered}$ |  |  |
| $\mathrm{V}_{\text {OL }}$ | Low-Level Output Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{I}_{\mathrm{OL}}=100 \mu \mathrm{~A} \end{aligned}$ | 1.65-5.5 |  |  | 0.1 |  | 0.1 | V |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{I}_{\mathrm{OH}}=4 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=8 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=12 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=16 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=24 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=32 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 1.65 \\ & 2.3 \\ & 2.7 \\ & 3.0 \\ & 3.0 \\ & 4.5 \end{aligned}$ |  | $\begin{aligned} & 0.08 \\ & 0.1 \\ & 0.12 \\ & 0.15 \\ & 0.22 \\ & 0.22 \end{aligned}$ | $\begin{gathered} 0.24 \\ 0.3 \\ 0.4 \\ 0.4 \\ 0.55 \\ 0.55 \end{gathered}$ |  | $\begin{gathered} 0.24 \\ 0.3 \\ 0.4 \\ 0.4 \\ 0.55 \\ 0.55 \end{gathered}$ |  |
| 1 N | Input <br> Leakage <br> Current | $0 \leq \mathrm{V}_{\mathrm{IN}} \leq 5.5 \mathrm{~V}$ | 0 to 5.5 |  |  | $\pm 0.1$ |  | $\pm 1.0$ | $\mu \mathrm{A}$ |
| IofF | Power-Off <br> Output <br> Leakage <br> Current | $\begin{aligned} & V_{\text {IN }} \text { or } V_{\text {OUT }}= \\ & 5.5 \mathrm{~V} \end{aligned}$ | 0 |  |  | 1.0 |  | 10 | $\mu \mathrm{A}$ |
| ICC | Quiescent Supply Current | $0 \leq \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{CC}}$ | 5.5 |  |  | 1.0 |  | 10 | $\mu \mathrm{A}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (Input $t_{r}=t_{f}=2.5 \mathrm{nS}$ )

| Symbol | Parameter | $\mathrm{V}_{\mathrm{cc}}$ <br> (V) | Test Condition | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $\begin{aligned} \mathrm{T}_{\mathrm{A}} & =-55^{\circ} \mathrm{C} \text { to } \\ & +125^{\circ} \mathrm{C} \end{aligned}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $\begin{aligned} & \hline \mathrm{tpLH}^{2}, \\ & \mathrm{t}_{\mathrm{PH}} \end{aligned}$ | Propagation Delay, Input to Output | 1.65-1.95 | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | 2.0 | 5.5 | 18.5 | 2.0 | 19 | ns |
|  |  | 2.3-2.7 | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | 0.8 | 3.0 | 11 | 0.8 | 11.5 |  |
|  |  | 3.0-3.6 | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | 0.5 | 2.6 | 7.5 | 0.5 | 8.0 |  |
|  |  |  | $\mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 1.5 | 3.0 | 8.5 | 1.5 | 9.0 |  |
|  |  | 4.5-5.5 | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{M} \Omega, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | 0.5 | 2.2 | 5.5 | 0.5 | 6.0 |  |
|  |  |  | $\mathrm{R}_{\mathrm{L}}=500 \Omega, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 0.8 | 2.4 | 7.0 | 0.8 | 7.5 |  |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance | 5.5 | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}$ |  | 4.0 |  |  |  | pF |
| $\mathrm{CPD}^{\text {P }}$ | Power Dissipation Capacitance (Note 7) | $\begin{aligned} & 3.3 \\ & 5.5 \end{aligned}$ | $\begin{gathered} 10 \mathrm{MHz} \\ \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{CC}} \end{gathered}$ |  | $\begin{aligned} & 20 \\ & 26 \end{aligned}$ |  |  |  | pF |

7. $C_{P D}$ is defined as the value of the internal equivalent capacitance which is calculated from the dynamic operating current consumption without load. Average operating current can be obtained by the equation $\mathrm{I}_{\mathrm{CC}(\mathrm{OPR})}=\mathrm{C}_{\mathrm{PD}} \bullet \mathrm{V}_{\mathrm{CC}} \bullet \mathrm{f}_{\mathrm{in}}+\mathrm{I}_{\mathrm{CC}} . \mathrm{C}_{\mathrm{PD}}$ is used to determine the no-load dynamic power consumption: $\mathrm{P}_{\mathrm{D}}=\mathrm{C}_{\mathrm{PD}} \bullet \mathrm{V}_{\mathrm{CC}}{ }^{2} \bullet \mathrm{f}_{\mathrm{in}}+\mathrm{I}_{\mathrm{CC}} \bullet \mathrm{V}_{\mathrm{CC}}$.

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$t_{R}=t_{F}=2.5 \mathrm{~ns}, 10 \%$ to $90 \%, f=1 \mathrm{MHz}, \mathrm{t}_{\mathrm{W}}=500 \mathrm{~ns}$
Figure 3. Switching Waveforms


A 1 MHz square input wave is recommended for propagation delay tests

Figure 4. Test Circuit

## ORDERING INFORMATION

| Device | Package | Shipping ${ }^{\dagger}$ |
| :--- | :---: | :---: |
| NLX1G11MUTCG <br> (In Development) | UDFN6, $1.2 \times 1.0,0.4 \mathrm{P}$ <br> (Pb-Free) | $3000 /$ Tape \& Reel |
| NLX1G11AMUTCG | UDFN6, $1.45 \times 1.0,0.5 P$ <br> (Pb-Free) | $3000 /$ Tape \& Reel |
| NLVX1G11AMUTCG* | UDFN6, $1.45 \times 1.0,0.5 P$ <br> (Pb-Free) | $3000 /$ Tape \& Reel |
| NLX1G11CMUTCG | UDFN6, $1.0 \times 1.0,0.35 P$ <br> (Pb-Free) | $3000 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

## NLX1G11

## PACKAGE DIMENSIONS



## NLX1G11

## PACKAGE DIMENSIONS



## NLX1G11

## PACKAGE DIMENSIONS

UDFN6 1.0x1.0, 0.35P
CASE 517BX
ISSUE O


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
. CONTROLLING DIMENSION: MILLIMETERS
2. DIMENSION b APPLIES TO PLATED

TERMINAL AND IS MEASURED BETWEEN
0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF

BURRS AND MOLD FLASH.

|  | MILLIMETERS |  |
| :---: | :---: | :---: |
| DIM | MIN | MAX |
| A | 0.45 | 0.55 |
| A1 | 0.00 | 0.05 |
| A3 | 0.13 REF |  |
| b | 0.12 | 0.22 |
| D | 1.00 BSC |  |
| E | 1.00 BSC |  |
| e | 0.35 |  |
|  | BSC |  |
| L | 0.25 | 0.35 |
| L1 | 0.30 | 0.40 |

RECOMMENDED SOLDERING FOOTPRINT*


DIMENSIONS: MILLIMETERS
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.


#### Abstract

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NLX1G97MUTCG 74LS38 74LVC32ADTR2G MC74HCT20ADTR2G NLV17SZ00DFT2G NLV17SZ02DFT2G NLV74HC02ADR2G
74HC32S14-13 74LS133 74LVC1G32Z-7 M38510/30402BDA 74LVC1G86Z-7 74LVC2G08RA3-7 NLV74HC08ADTR2G
NLV74HC14ADR2G NLV74HC20ADR2G NLX2G86MUTCG 5962-8973601DA 74LVC2G02HD4-7 NLU1G00AMUTCG
74LVC2G32RA3-7 74LVC2G00HD4-7 NL17SG02P5T5G 74LVC2G00HK3-7 74LVC2G86HK3-7 NLX1G99DMUTWG NLVVHC1G00DFT2G NLVHC1G08DFT2G NLV7SZ57DFT2G NLV74VHC04DTR2G NLV27WZ86USG NLV27WZ00USG

NLU1G86CMUTCG NLU1G08CMUTCG NL17SZ32P5T5G NL17SZ00P5T5G NL17SH02P5T5G 74AUP2G00RA3-7
NLV74HC02ADTR2G NLX1G332CMUTCG NL17SG86P5T5G NL17SZ05P5T5G NLV74VHC00DTR2G


[^0]:    H - HIGH Logic Level
    L - LOW Logic Level
    X = Either LOW or HIGH Logic Level

